

# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier

## Features

- ✕ 33.5 dBm Output IP3 @ 850 MHz
- ✕ 4.1 dB Noise Figure @ 850 MHz
- ✕ 15.2 dB Gain @ 850 MHz
- ✕ 18.0 dBm P1dB @ 850 MHz
- ✕ Low Performance Variation Over Temperature
- ✕ 100% DC On-Wafer Testing
- ✕ ESD Protection on All Die: >1000V HBM
- ✕ Low Thermal Resistance: <85°C/Watt

## Description

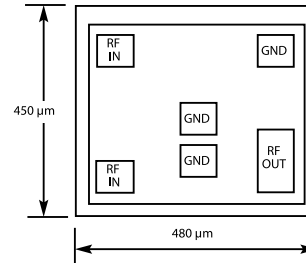
The CGB7006-BD is a Darlington Configured, high dynamic range, utility gain block amplifier. Designed for applications operating within the DC to 6.0 GHz frequency range, Mimix's broadband, cascadable, gain block amplifiers are ideal solutions for transmit, receive and IF applications.

These MMIC amplifiers are available in bare die form. Mimix's InGaP HBT technology and an industry low thermal resistance offers a thermally robust and reliable gain block solution.

The InGaP HBT die have extra pads to enable thorough DC testing. This unique test capability and the inclusion of ESD protection on all die, significantly enhances the quality, reliability and ruggedness of these products.

With a single bypass capacitor, optional RF choke and two DC blocking capacitors, this gain block amplifier offers significant ease of use in a broad range of applications.

## Chip Layout



## Absolute Maximum Ratings

Max Device Voltage	+6.0 V
Max Device Current	130 mA
Max Device Dissipated Power	0.65 W
RF Input Power	+17 dBm
Storage Temperature	-55°C to 150°C
Junction Temperature	150°C
Operating Temperature	-40°C to +85°C
Thermal Resistance	80° C/W
EDS (HBM)	1000 V

Operation of this device above any of these parameters may cause permanent damage.

## Applications

- ✕ PA Driver Amp, IF Amp, LO Buffer Amp
- ✕ Cellular, PCS, GSM, UMTS
- ✕ Wireless Data and SATCOM
- ✕ Transmit and Receive Functions
- ✕ CATV

## Typical Performance

Parameter	Temperature (°C)	850 MHz			1950 MHz			2400 MHz			3500 MHz			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Small Signal Gain	+25	14.0	15.2	16.4	13.3	14.5	15.7	13.0	14.2	15.4		13.5		dB
	-40 to +85	13.8	15.2	16.6	13.1	14.5	15.9	12.8	14.2	15.6		13.5		dB
Output P1dB	+25	17.0	18.0		16.5	17.5		15.8	16.8			15.5		dBm
	-40 to +85	16.5	18.0		16.2	17.5		15.6	16.8			15.5		dBm
Output IP3	+25	32.0	33.5		30.5	32.0		29.0	30.5			28.0		dBm
	-40 to +85	31.5	33.5		29.5	32.0		28.5	30.5			28.0		dBm
Noise Figure	+25		4.1	5.0		4.1	5.0		4.2	5.0		4.4		dB
	-40 to +85		4.1	5.3		4.1	5.3		4.2	5.4		4.4		dB
Operating Current	+25	60	64	68	60	64	68	60	64	68		64		mA
	-40 to +85	57	64	71	57	64	71	57	64	71		64		mA
Input Return Loss	+25	15	19		12	17		13	17			12		dB
	-40 to +85	14	9		11	17		12	17			12		dB
Output Return Loss	+25	18	25		12	17		11.0	17			19		dB
	-40 to +85	17	25		11	17		10.5	17			19		dB
Pout @ -45 dBc, ACP IS-95, 9 Forward Channels	+25		12			12								dBm
	-40 to +85		12			12								dBm

Notes: 1. Performance in Mimix eval board,  $V_s = 8\text{ V}$ ,  $I_d = 64\text{ mA}$  Typ.,  $R_{bias} = 47\ \Omega$ ,  $Z_s = Z_L = 50\ \Omega$ , OIP3 tone spacing = 1 MHz, Pout per tone = 3 dBm.  
2. Values reflect performance in recommended application circuit.  
3. Only on-wafer DC test is done. Devices are not tested for RF performance.

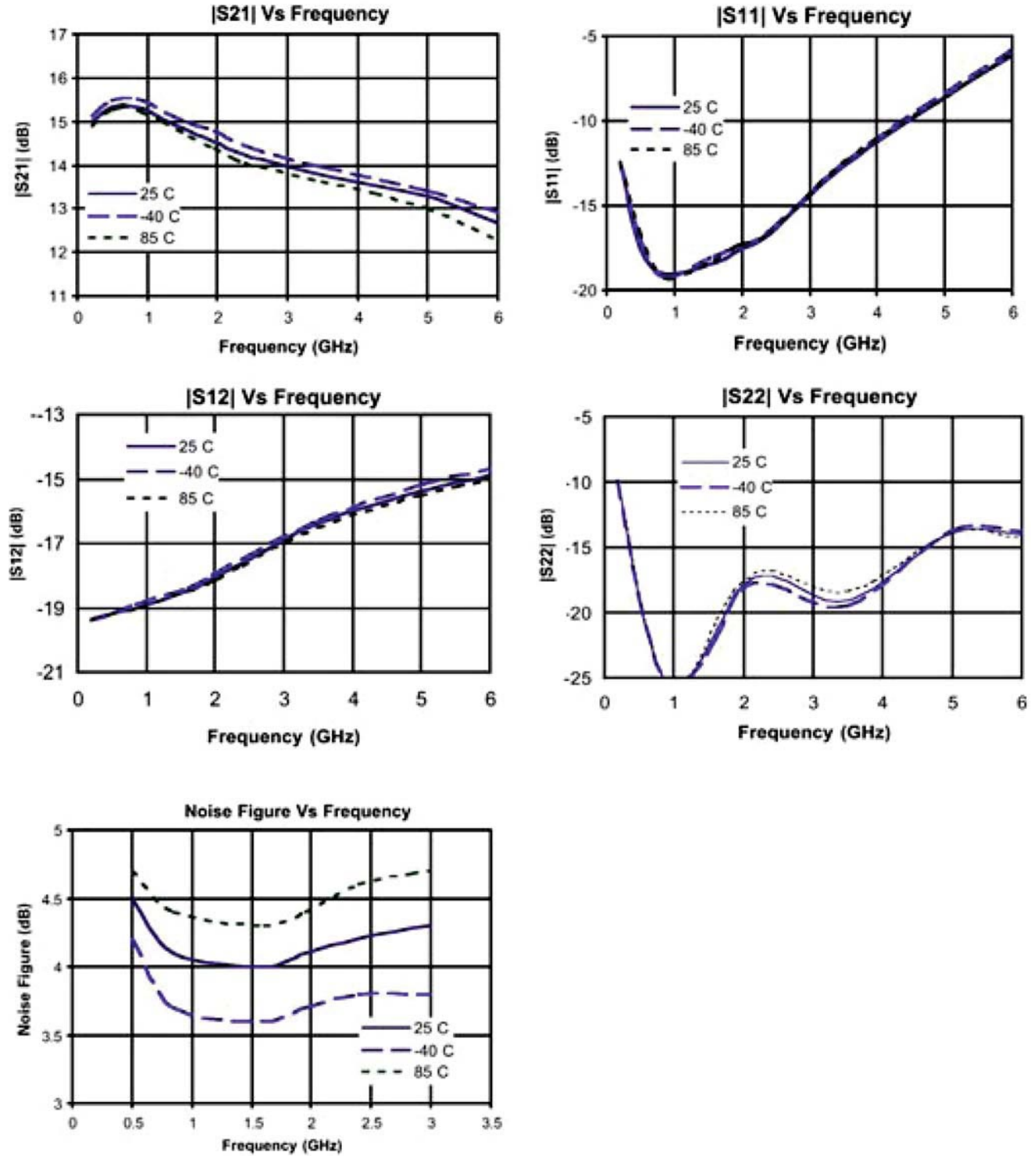
# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier



April 2007 - Rev 02-Apr-07

**CGB7006-BD**  
RoHS

## Typical S-Parameter and Noise Performance



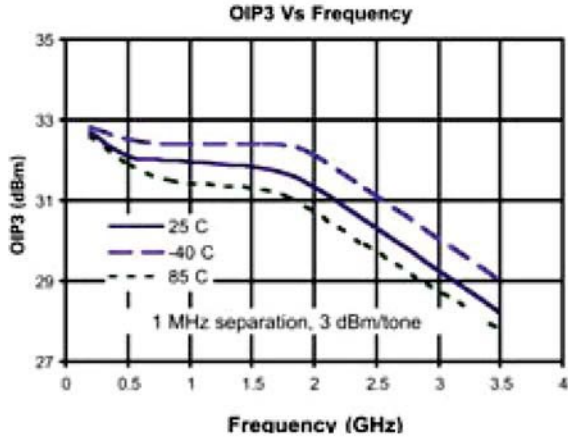
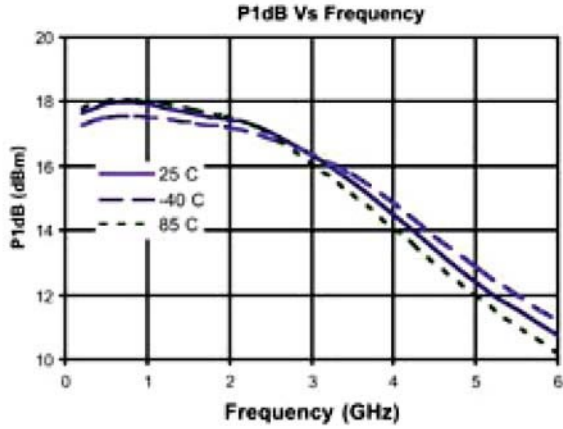
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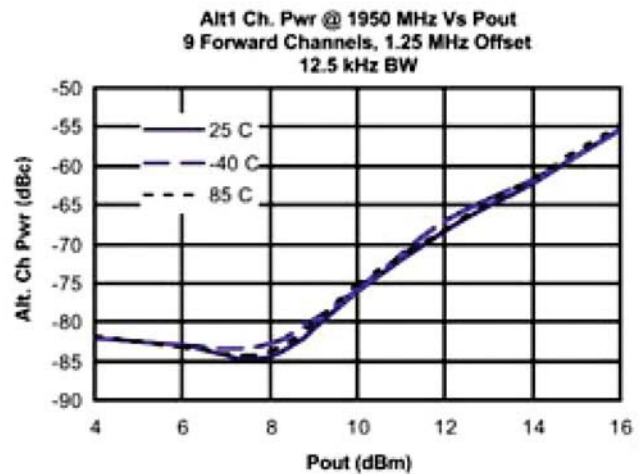
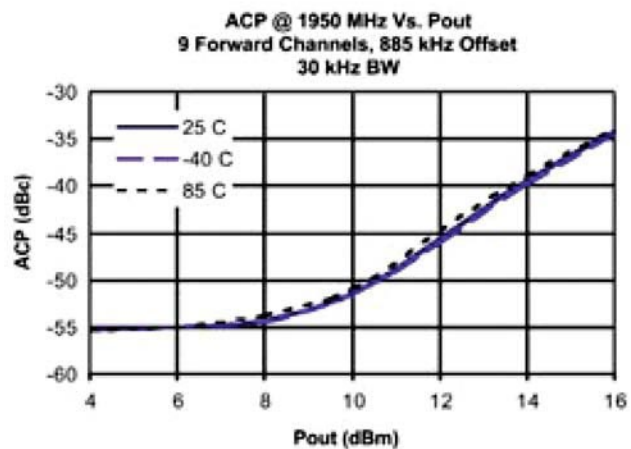
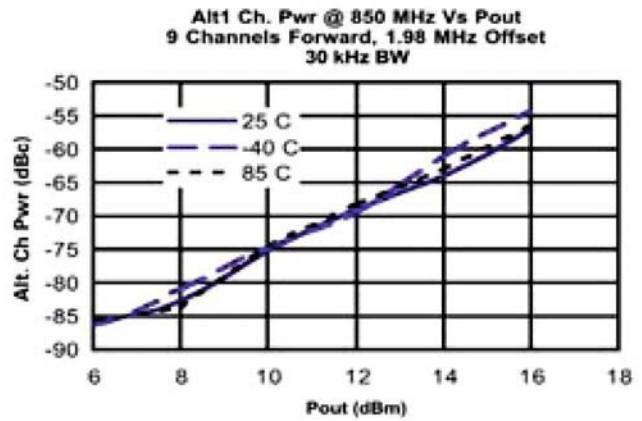
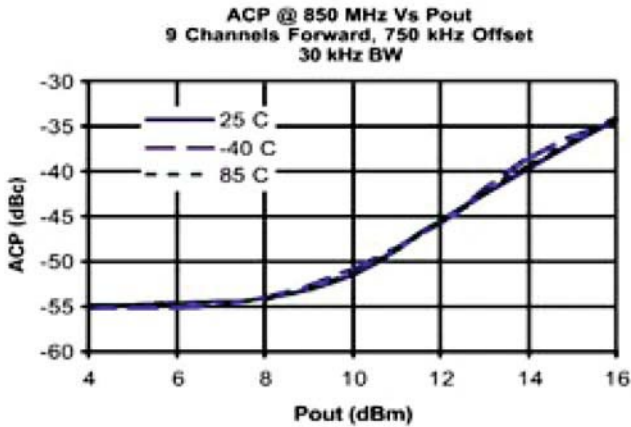
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## Typical Power and Linearity Performance



### Linearity Performance - Base Station ACP - IS-95



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## Typical Scattering Parameters (Vd = +5.08V, Icc = 62 mA, T = 23°C, device in a 50 ohm system)

Frequency (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)
100	0.039	-174.5	5.99	174.90	0.114	-1.56	0.039	-10.97
200	0.041	-166.2	5.96	169.80	0.114	-3.31	0.041	-22.43
300	0.043	-160.1	5.95	164.90	0.114	-4.91	0.043	-33.03
400	0.045	-155.0	5.92	160.00	0.114	-6.50	0.046	-41.32
500	0.048	-149.6	5.90	155.10	0.114	-8.03	0.050	-48.80
600	0.052	-146.0	5.88	150.20	0.115	-9.64	0.055	-55.93
700	0.057	-143.6	5.86	145.30	0.115	-11.20	0.059	-62.24
800	0.062	-141.6	5.83	140.50	0.115	-12.75	0.063	-67.62
900	0.067	-139.6	5.81	135.70	0.116	-14.43	0.068	-72.66
1000	0.073	-138.8	5.78	130.90	0.116	-16.03	0.074	-77.48
1100	0.078	-138.3	5.75	126.10	0.117	-17.72	0.079	-81.90
1200	0.084	-138.0	5.72	121.30	0.117	-19.43	0.084	-85.36
1300	0.091	-138.1	5.69	116.50	0.118	-21.01	0.089	-89.25
1400	0.096	-138.7	5.66	111.80	0.119	-22.77	0.095	-92.61
1500	0.103	-139.2	5.62	107.00	0.120	-24.47	0.100	-95.85
1600	0.110	-140.0	5.59	102.30	0.120	-26.12	0.105	-98.76
1700	0.116	-141.1	5.55	97.63	0.121	-27.85	0.111	-101.70
1800	0.123	-142.4	5.51	92.96	0.122	-29.71	0.116	-104.70
1900	0.129	-143.7	5.48	88.36	0.123	-31.41	0.122	-107.40
2000	0.136	-145.2	5.44	83.74	0.124	-33.23	0.127	-110.20
2100	0.143	-147.0	5.41	79.10	0.125	-35.03	0.133	-112.70
2200	0.149	-148.7	5.37	74.51	0.126	-36.84	0.139	-115.50
2300	0.156	-150.7	5.33	69.96	0.128	-38.68	0.144	-118.10
2400	0.162	-152.8	5.30	65.42	0.129	-40.59	0.149	-120.90
2500	0.168	-154.9	5.26	60.88	0.130	-42.48	0.155	-123.70
2600	0.174	-157.2	5.22	56.41	0.131	-44.31	0.160	-126.20
2700	0.180	-159.5	5.19	51.95	0.133	-46.20	0.165	-129.00
2800	0.186	-162.1	5.16	47.52	0.134	-48.18	0.171	-131.90
2900	0.192	-165.0	5.13	43.08	0.136	-50.11	0.176	-135.20
3000	0.198	-167.7	5.10	38.61	0.137	-52.05	0.181	-138.20
3100	0.203	-170.6	5.08	34.22	0.139	-54.06	0.187	-141.40
3200	0.209	-173.6	5.05	29.77	0.141	-56.16	0.192	-144.70
3300	0.215	-176.9	5.03	25.36	0.142	-58.20	0.197	-148.20
3400	0.221	179.6	5.01	20.91	0.145	-60.38	0.202	-151.80
3500	0.226	176.1	4.98	16.48	0.146	-62.47	0.207	-155.20
3600	0.232	172.7	4.96	12.05	0.148	-64.69	0.212	-158.90
3700	0.237	169.0	4.94	7.66	0.151	-66.87	0.216	-162.70
3800	0.242	165.0	4.93	3.24	0.153	-69.07	0.220	-167.00
3900	0.246	160.6	4.91	-1.21	0.155	-71.40	0.224	-171.10
4000	0.251	156.4	4.90	-5.64	0.157	-73.64	0.227	-175.40
4100	0.255	152.0	4.89	-10.07	0.160	-76.03	0.231	180.00
4200	0.258	147.3	4.88	-14.55	0.162	-78.46	0.234	175.20
4300	0.262	142.2	4.88	-19.05	0.165	-80.86	0.237	170.10
4400	0.266	137.0	4.88	-23.58	0.168	-83.39	0.239	164.50
4500	0.270	131.5	4.87	-28.17	0.171	-86.02	0.241	158.90
4600	0.273	126.1	4.87	-32.75	0.174	-88.62	0.244	153.00
4700	0.277	120.5	4.87	-37.38	0.176	-91.28	0.248	147.00
4800	0.281	114.3	4.88	-42.06	0.180	-94.09	0.252	140.40
4900	0.287	107.8	4.88	-46.79	0.183	-96.98	0.256	133.50
5000	0.292	101.1	4.88	-51.64	0.186	-99.92	0.260	126.10

Continues Next Page. S-Parameter Data Files are available online at: [www.mimixbroadband.com](http://www.mimixbroadband.com)

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April 2007 - Rev 02-Apr-07

**CGB7006-BD**  
**RoHS**

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Frequency (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)
5100	0.298	94.52	4.88	-56.50	0.189	-103.0	0.265	119.00
5200	0.304	87.85	4.89	-61.36	0.192	-106.0	0.271	111.70
5300	0.312	80.74	4.89	-66.39	0.196	-109.2	0.280	103.90
5400	0.321	73.09	4.89	-71.54	0.199	-112.5	0.289	95.56
5500	0.331	65.45	4.89	-76.72	0.202	-115.9	0.298	87.18
5600	0.343	58.07	4.88	-81.88	0.205	-119.5	0.310	79.10
5700	0.356	50.40	4.88	-87.26	0.208	-123.0	0.325	71.06
5800	0.370	42.60	4.87	-92.77	0.211	-126.8	0.341	62.28
5900	0.384	34.37	4.84	-98.37	0.213	-130.8	0.359	53.49
6000	0.400	26.43	4.81	-104.00	0.215	-134.6	0.378	45.11
6100	0.418	18.66	4.77	-109.60	0.216	-138.6	0.400	36.81
6200	0.435	11.03	4.72	-115.40	0.217	-142.6	0.423	28.76
6300	0.452	3.33	4.66	-121.20	0.218	-146.8	0.446	20.96
6400	0.470	-4.49	4.59	-127.00	0.218	-151.0	0.472	13.18
6500	0.488	-12.03	4.50	-132.90	0.217	-155.2	0.496	5.55
6600	0.506	-19.24	4.40	-138.70	0.215	-159.4	0.521	-1.78
6700	0.523	-26.11	4.30	-144.50	0.214	-163.5	0.545	-8.68
6800	0.537	-32.99	4.19	-150.30	0.211	-167.7	0.569	-15.38
6900	0.551	-39.84	4.08	-156.00	0.208	-171.8	0.592	-21.94
7000	0.565	-46.61	3.95	-161.70	0.205	-175.9	0.614	-28.48
7100	0.577	-52.93	3.81	-167.20	0.200	-179.8	0.634	-34.66
7200	0.587	-58.95	3.68	-172.70	0.196	176.3	0.652	-40.64
7300	0.595	-64.82	3.55	-178.00	0.192	172.5	0.668	-46.24
7400	0.602	-70.70	3.42	-176.70	0.187	168.8	0.684	-51.69
7500	0.608	-76.42	3.28	171.60	0.182	165.2	0.699	-57.04
7600	0.615	-81.75	3.14	166.60	0.177	161.9	0.712	-62.18
7700	0.619	-86.78	3.01	161.70	0.172	158.6	0.723	-67.01
7800	0.620	-91.54	2.89	157.10	0.167	155.5	0.733	-71.58
7900	0.621	-96.31	2.77	152.40	0.163	152.4	0.741	-75.96
8000	0.620	-101.10	2.65	147.80	0.158	149.6	0.749	-80.18
8100	0.622	-105.60	2.54	143.40	0.154	146.6	0.757	-84.30
8200	0.621	-109.60	2.42	139.20	0.149	143.9	0.764	-88.24
8300	0.618	-113.50	2.32	135.00	0.145	141.4	0.769	-91.84
8400	0.614	-117.30	2.23	131.00	0.141	138.8	0.773	-95.36
8500	0.609	-121.30	2.14	126.90	0.137	136.5	0.777	-98.78
8600	0.605	-125.20	2.05	122.90	0.133	133.9	0.781	-102.10
8700	0.602	-128.80	1.97	119.10	0.130	131.7	0.784	-105.30
8800	0.596	-132.00	1.89	115.30	0.126	129.6	0.787	-108.40
8900	0.588	-135.30	1.81	111.50	0.123	127.4	0.788	-111.30
9000	0.580	-138.80	1.75	107.80	0.121	125.4	0.789	-114.10
9100	0.573	-142.40	1.68	104.10	0.118	123.3	0.790	-116.90
9200	0.566	-145.70	1.61	100.40	0.115	121.1	0.792	-119.60
9300	0.559	-148.70	1.55	96.82	0.112	119.2	0.793	-122.30
9400	0.549	-151.50	1.50	93.27	0.110	117.2	0.795	-124.90
9500	0.539	-154.60	1.44	89.72	0.108	115.4	0.794	-127.30
9600	0.528	-157.90	1.39	86.22	0.106	113.5	0.794	-129.80
9700	0.520	-161.00	1.34	82.65	0.104	111.5	0.795	-132.20
9800	0.512	-163.70	1.29	79.26	0.102	109.8	0.795	-134.50
9900	0.501	-166.10	1.24	75.89	0.100	108.0	0.795	-136.70
10000	0.487	-168.60	1.20	72.49	0.098	106.5	0.795	-138.90

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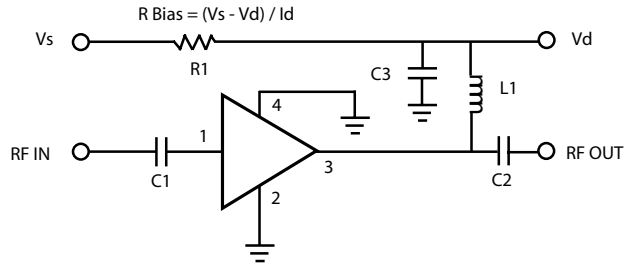
# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier

## Application Circuit

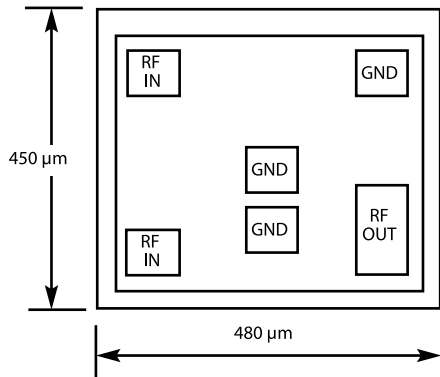
Note: This schematic represents the topology of the application circuit recommended by Mimix.

Recommended Bias Resistor Values for ID = 63 mA				
Supply Voltage (Vs)	7V	8V	10V	12V
Rbias (1/4W)	31 Ω	47Ω	—	—
Rbias (1/2W)	—	—	78Ω	110 Ω

Note: Rbias provides DC bias stability over temperature.



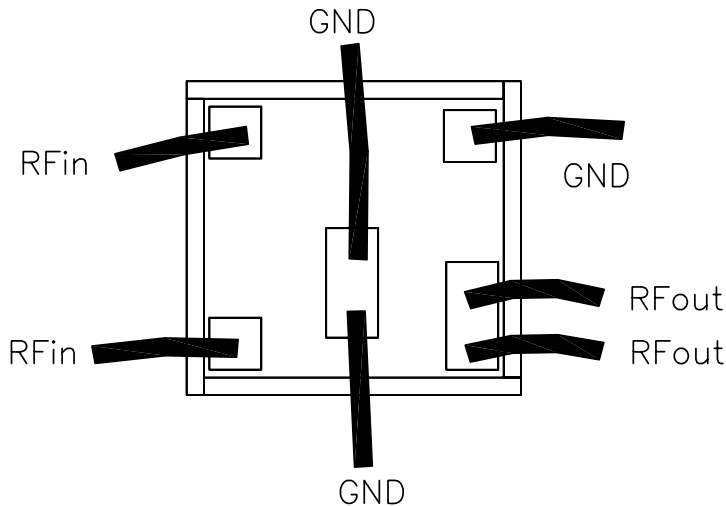
## Physical Dimensions



Notes:  
RF OUT bonding pad is 75 μm x 155 μm.  
All other pads are 75 μm x 75 μm.

Ref Designator	Value
C1, C2	1000 pF
C3	1.0 μF
L1	56 nH
R 1	$R_{Bias} = (V_s - V_d) / I_d$

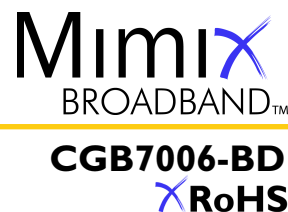
## Bonding Configuration



**Caution: ESD Sensitive**  
Appropriate precautions in handling, packaging  
and testing devices must be observed.



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## Handling and Assembly Information

**CAUTION!** - Mimix Broadband MMIC Products contain gallium arsenide (GaAs) which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- *Do not ingest.*
- *Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.*
- *Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.*

**Life Support Policy** - Mimix Broadband's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President and General Counsel of Mimix Broadband. As used herein: (1) Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user. (2) A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**ESD** - Gallium Arsenide (GaAs) devices are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic containers, which should be opened in cleanroom conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickups or, with care, sharp tweezers.

**Die Attachment** - GaAs Products from Mimix Broadband are 0.100 mm (0.004") thick. Microstrip substrates should be brought as close to the die as possible. The mounting surface should be clean and flat. If using conductive epoxy, recommended epoxies are Tanaka TS3332LD, Die Mat DM6030HK or DM6030HK-Pt cured in a nitrogen atmosphere per manufacturer's cure schedule. Apply epoxy sparingly to avoid getting any on to the top surface of the die. An epoxy fillet should be visible around the total die periphery. For additional information please see the Mimix "Epoxy Specifications for Bare Die" application note.

**Wire Bonding** - Windows in the surface passivation above the bond pads are provided to allow wire bonding to the die's gold bond pads. The recommended wire bonding procedure uses Gold 0.025 mm (0.001") diameter ball bonds. Aluminum wire should be avoided. Thermo-compression bonding is recommended though thermosonic bonding may be used providing the ultrasonic content of the bond is minimized. Bond force, time and ultrasonics are all critical parameters. Bonds should be made from the bond pads on the die to the package or substrate. All bonds should be as short as possible.

<b>Part Number for Ordering</b>	<b>Description</b>
CGB7006-BD-000V	RoHS compliant die packed in vacuum release gel paks